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N-Channel PowerTrench[®] MOSFET 30 V, 22 A, 10 m Ω

Features

- Max $r_{DS(on)}$ = 10 m Ω at V_{GS} = 10 V, I_D = 13.5 A
- Max $r_{DS(on)}$ = 15 m Ω at V_{GS} = 4.5 V, I_D = 11.0 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

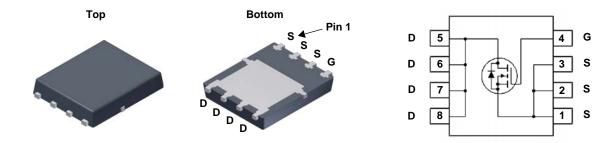


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- IMVP Vcore Switching for Notebook
- VRM Vcore Switching for Desktop and server
- OringFET / Load Switching
- DC-DC Conversion



Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		22		
	-Continuous (Silicon limited)	T _C = 25 °C		44		
	-Continuous	T _A = 25 °C	(Note 1a)	13.5	Α	
	-Pulsed			50		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	29	mJ	
P _D	Power Dissipation	T _C = 25 °C	29		14/	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	4.4	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a	a) 50	0/11

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7698	FDMS7698	Power 56	13 "	12 mm	3000 units

FDMS7698 N-Channel PowerTrench[®] MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	octeristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	30			V	
ΔBV _{DSS} ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		16		mV/°C	
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μΑ	
GSS	Gate to Source Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	2.0	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C	
		V _{GS} = 10 V, I _D = 13.5 A		8.1	10	-	
r _{DS(on)}	Static Drain to Source On Registence	V _{GS} = 4.5 V, I _D = 11.0 A		12.2	15		
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 13.5 A T _J = 125 °C		11	14	– mΩ	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 13.5 A		53		S	
C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		1205 370 35	1605 495 55	pF pF pF	
C _{rss} R _g	Gate Resistance		0.3	35 1.6	3.2	ρг	
Switching	g Characteristics				10		
t _{d(on)}	Turn-On Delay Time Rise Time			9 3	18 10	ns	
r	Turn-Off Delay Time	V_{DD} = 15 V, I _D = 13.5 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		20	36	ns ns	
d(off)	Fall Time	1GS - 10 1, 1 GEN - 0 12		3	10	ns	
Q _q	Total Gate Charge	V _{GS} = 0 V to 10 V		17	24	nC	
∝ _g Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 15 V$,		7.5	12	nC	
Q _{gs}	Gate to Source Charge	$I_{\rm D} = 13.5 \text{ A}$		3.9		nC	
Q _{gd}	Gate to Drain "Miller" Charge			2.0		nC	
	urce Diode Characteristics	1					
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.75	1.1	V	
V _{SD}		$V_{GS} = 0 V, I_S = 13.5 A$ (Note 2)		0.86	1.2		
rr	Reverse Recovery Time			24	38	ns	
2 _{rr}	Reverse Recovery Charge	I _F = 13.5 A, di/dt = 100 A/μs		8	15	nC	
t _{rr}	Reverse Recovery Time			19	34	ns	
Q _{rr}	Reverse Recovery Charge	I _F = 13.5 A, di/dt = 300 A/μs		13	24	nC	

Notes:

1. $R_{\theta,JR}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.



2. Pulse Test: Pulse Width < 300 $\mu \text{s},$ Duty cycle < 2.0%.

3. E_{AS} of 29 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 14 A, V_{DD} = 27 V, V_{GS} = 10 V.

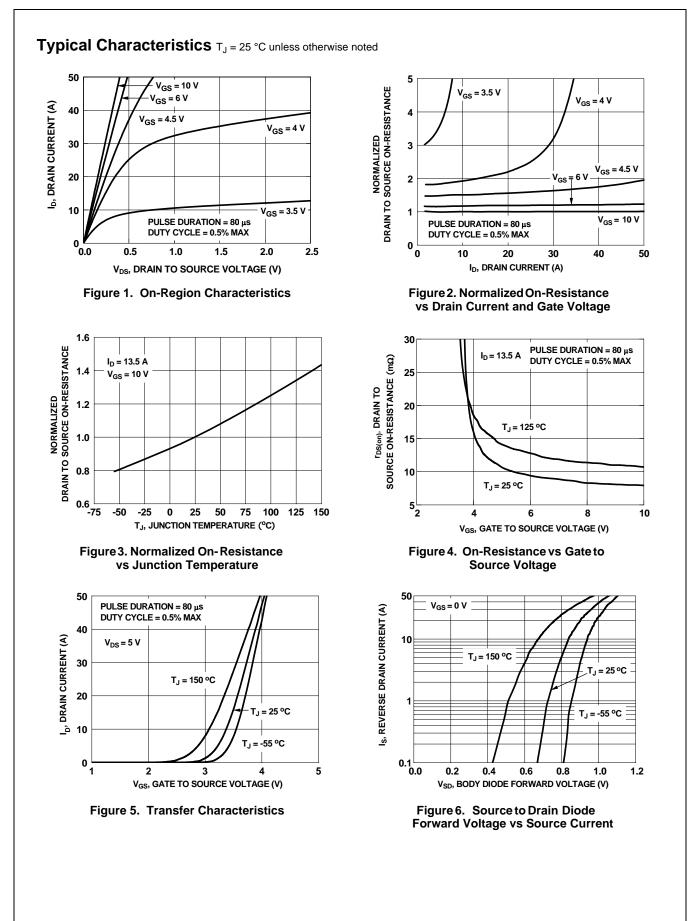
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

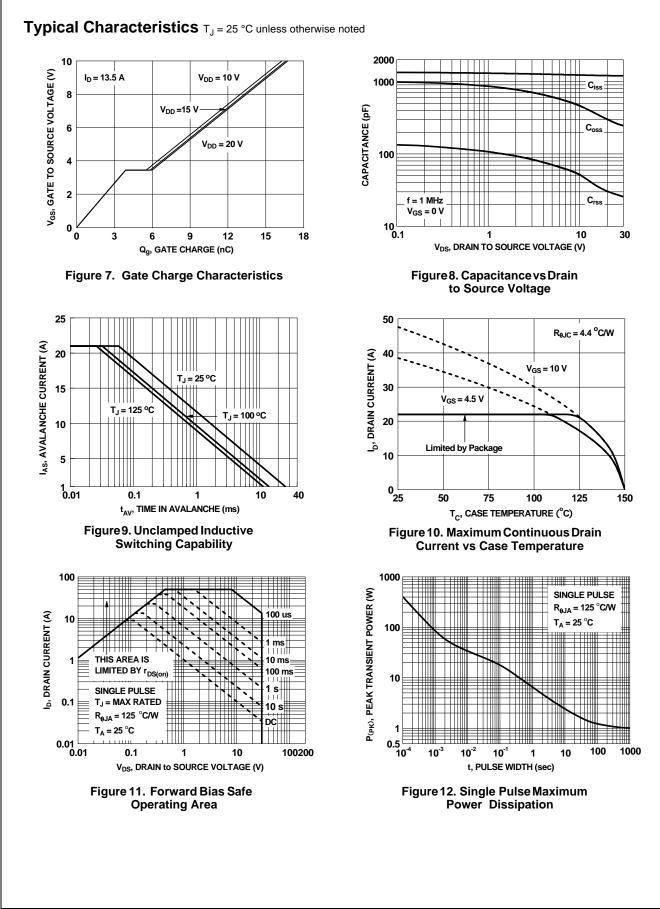
a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper

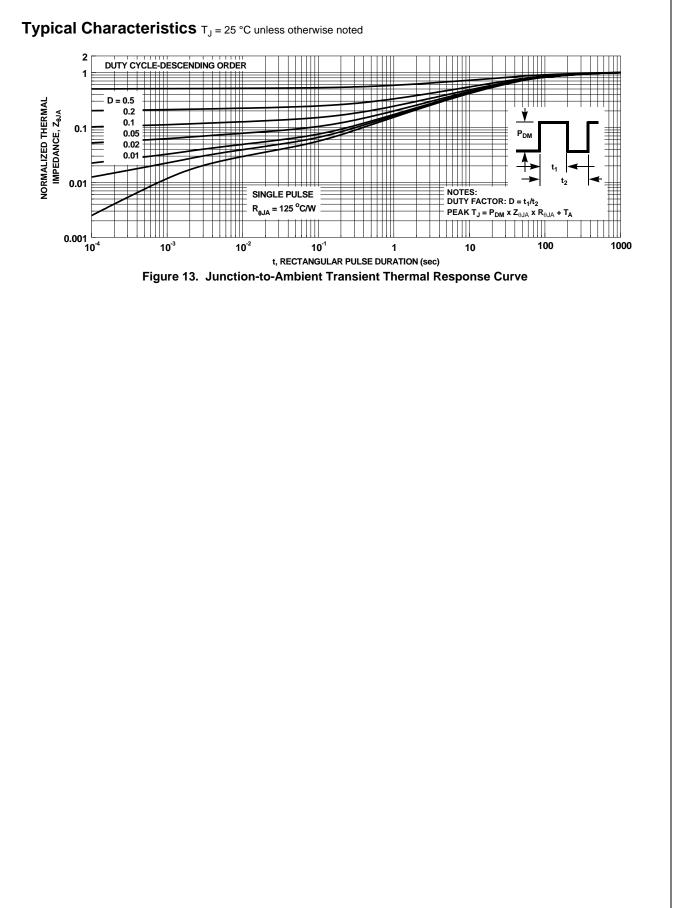
b) 125 °C/W when mounted on a minimum pad of 2 oz copper.



FDMS7698 N-Channel PowerTrench[®] MOSFET









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